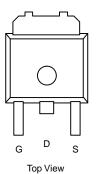
RoHS

COMPLIANT

N-Channel 200 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)		
200	0.180 at V _{GS} = 10 V	18		
200	0.255 at V _{GS} = 4.5 V	10		



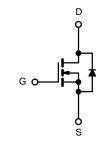


FEATURES DT-Trench Power MOSFET

- 100 % Rgand UIS Tested
- 175 °C Junction Temperature

APPLICATIONS

- DC/DC Converters
- DC/AC Inverters
- Motor Drives



N-Channel MOSFET

ABSOLUTE MAXIMUM RAT	FINGS (T _C = 25 °C, unless c	otherwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	200	V	
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current	T _C = 25 °C		18	
Continuous Drain Current	T _C = 70 °C	I _D	7.5	А
Pulsed Drain Current (t = 300 µs)	I _{DM}	72	~	
Avalanche Current	I _{AS}	25		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	15.7	mJ
Maximum Power Dissipation ^a	T _C = 25 °C	Р	85 ^b	w
	T _A = 25 °C ^c	P _D –	4.1	vv
Operating Junction and Storage Tempera	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	60	°C/W		
Junction-to-Case (Drain)	R _{thJC}	1.5	C/W		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	· · · · · · · · · · · · · · · · · · ·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$				v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		3	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 160 V, V _{GS} = 0 V, T _J = 125 °C			50	μA	
		V _{DS} = 160 V, V _{GS} = 0 V, T _J = 175 °C			250	-	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	18			А	
Drain Course On Chata Desintence		V _{GS} = 10 V, I _D = 8 A		0.180	0.220	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 6 A		0.255	0.315		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 6 A		20		S	
Dynamic ^b	•	· · · · · · · · · · · · · · · · · · ·					
Input Capacitance	C _{iss}			2260		pF	
Output Capacitance	C _{oss}	V _{DS} = 160 V, V _{GS} = 0 V, f = 1 MHz		685			
Reverse Transfer Capacitance	C _{rss}			40			
Total Gate Charge ^c	Qg			19.8	30	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 160 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 8 \text{ A}$		3.6			
Gate-Drain Charge ^c	Q _{gd}			4.1		1	
Gate Resistance	R _q	f = 1 MHz		2		Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16		
Rise Time ^c	t _r	V _{DD} = 160 V, R _I = 9.6 Ω		11	20	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 8 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		18	27		
Fall Time ^c	t _f			5	10		
Drain-Source Body Diode Ratings an	nd Characteri	stics ^b T _C = 25 °C					
Continuous Current	۱ _S				18		
Pulsed Current	I _{SM}			1	72	A	
Forward Voltage ^a	V _{SD}	I _F = 5.2 A, V _{GS} = 0 V		0.7	1.2	V	
Reverse Recovery Time	t _{rr}			34	51	ns	

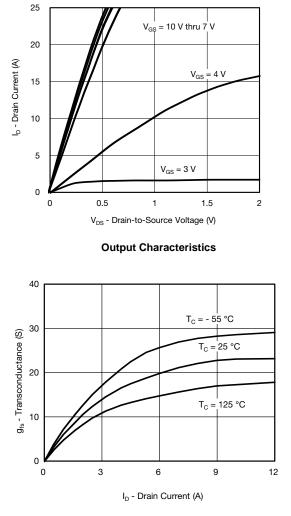
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.

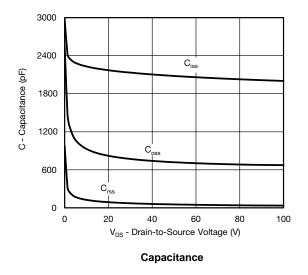
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

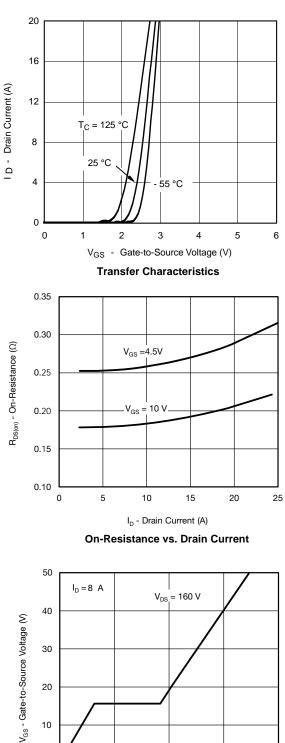


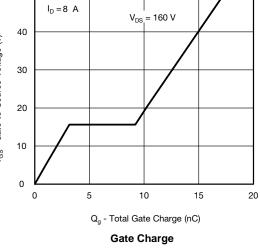
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Transconductance

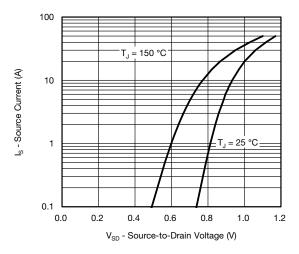




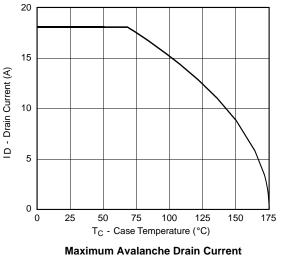




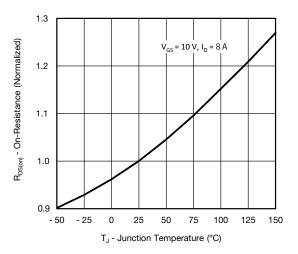
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



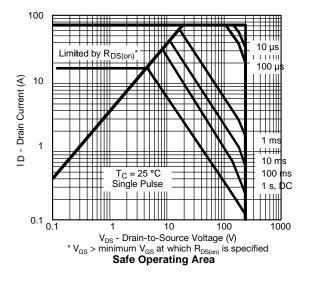
Source-Drain Diode Forward Voltage



vs. Case Temperature

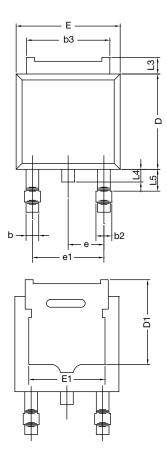


On-Resistance vs. Junction Temperature











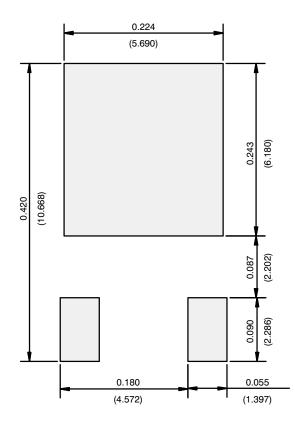
	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	5.21	-	0.205	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
е	2.28 BSC		0.090 BSC	
e1	4.56	BSC	0.180 BSC	
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.14	1.52	0.045	0.060
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347				

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

www.din-tek.jp

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